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**Part Number:** **0737801255**  
**Status:** **Active**  
**Overview:** HDM Backplane Connector System  
**Description:** HDM Board-to-Board Daughtercard Receptacle, Vertical, Signal Module, 144 Circuits, Mounted Height 15.00mm, Pin Length 3.50mm, Solder Tail

**Documents:**

[3D Model](#) [Product Specification PS-73780-999-001 \(PDF\)](#)  
[3D Model \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)  
[Drawing \(PDF\)](#)

**Agency Certification**

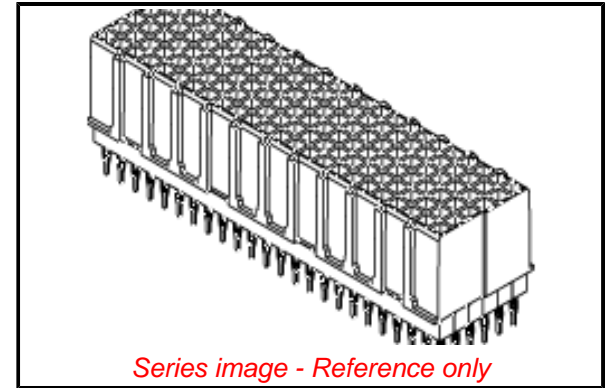
UL E29179

**General**

Product Family Backplane Connectors  
Series 73780  
Application Daughtercard, Mezzanine  
Comments Solder Tail  
Component Type PCB Receptacle  
Overview HDM Backplane Connector System  
Product Name HDM  
UPC 822348038732

**Physical**

Circuits (Loaded) 144  
Circuits (maximum) 144  
Color - Resin Black  
Durability (mating cycles max) 250  
First Mate / Last Break No  
Flammability 94V-0  
Guide to Mating Part No  
Keying to Mating Part None  
Material - Metal Copper-Nickel-Tin  
Material - Plating Mating Gold  
Material - Plating Termination Tin  
Material - Resin High Temperature Thermoplastic  
Net Weight 20.030/g  
Number of Columns 24  
Number of Pairs Open Pin Field  
Number of Rows 6  
Orientation Vertical  
PC Tail Length 3.50mm  
PCB Locator No  
PCB Retention None  
PCB Thickness - Recommended 1.60mm  
Packaging Type Tube  
Pitch - Mating Interface 2.00mm  
Pitch - Termination Interface 2.00mm  
Plating min - Mating 0.762µm  
Plating min - Termination 2.540µm  
Polarized to PCB No  
Stackable Yes  
Surface Mount Compatible (SMC) Yes  
Temperature Range - Operating -55° to +105°C  
Termination Interface: Style Through Hole



**EU ELV**

**Not Relevant**

**EU RoHS**

**Compliant**

**REACH SVHC**

Not Contained Per -  
D(2020)9139-DC (19  
Jan 2021)

**Halogen-Free**

**Status**

**Low-Halogen**

For more information, please visit [Contact US](#)

China ROHS

ELV

RoHS Phthalates

**China RoHS**

Green Image

Not Relevant

Not Contained

**Search Parts in this Series**

73780 Series

**Mates With**

HDM Board-to-Board Backplane Header  
73642 , 73643 , 73644 , 73942 , 73943 ,  
73944 , 74349 , 74428. HDM Board-to-  
Board Stacking Header 73769 , 73770 ,  
73782 , 73783 , 73771

**Electrical**

Current - Maximum per Contact	15.0A, 1.0A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC

**Solder Process Data**

Duration at Max. Process Temperature (seconds)	005
Lead-freeProcess Capability	WAVE
Max. Cycles at Max. Process Temperature	001
Process Temperature max. C	260

**Material Info****Reference - Drawing Numbers**

Product Specification	PS-73780-999-001
Sales Drawing	SD-73780-004-001

This document was generated on 09/27/2021

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